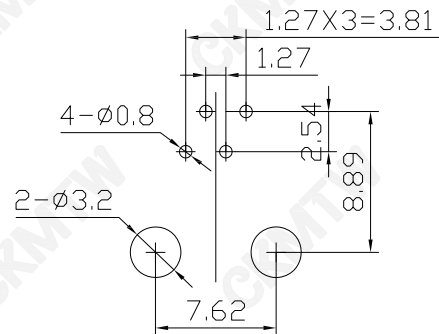
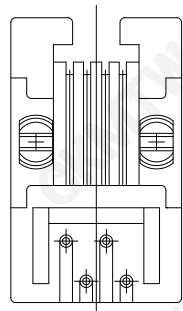
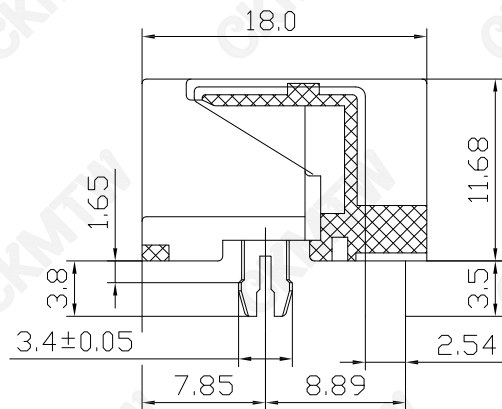
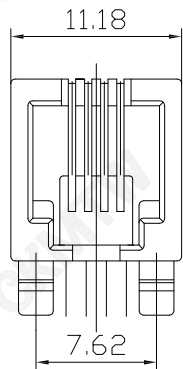




PC Board Layout  
Component Side Shown

NOTES:

MATERIAL:

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.  
2.CONTACT MATERIAL :PHOSPHOR BRONZE t=0.35mm.  
3.PLATING : GOLD PLATING OVER NICKEL

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.  
2.CURRENT RATING :1.5 AMP.  
3.CONTACT RESISTANCE :30 MILLIOHMS MAX.  
4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .  
5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

- 1.DURRABILITY: :750 CYCLES MIN.  
2.PCB RETENTION PRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

- 1.STORAGE : -40°C TO 85°C.  
2.OPERATION : -25°C TO 85°C.

TOLERANCE TABLE

|      |       |
|------|-------|
| .0   | ±0.30 |
| .00  | ±0.20 |
| .000 | ±0.05 |

|               |                     |                                                   |                 |       |        |
|---------------|---------------------|---------------------------------------------------|-----------------|-------|--------|
| APPROVED:     | DATE:               | C kmtw 深圳市灿科盟实业有限公司<br>CHANKEMENG INDUSTRYCO.,LTD |                 |       |        |
| CHECKED:      | DATE:               | TITLE:<br>RJ11-4P/4C 53A 弯插 全塑 无耳H:18 黑色          |                 |       |        |
| DRAWN:<br>HCY | DATE:<br>2024-06-18 | PART. NO.                                         | R-RJ11R04P-A000 |       |        |
|               |                     | UNIT                                              | mm              | SCALE | free   |
|               |                     | FILE NO.                                          | Ckmtw-RJ11-0046 | REV.  | A HY04 |